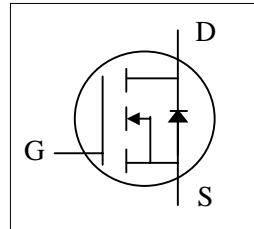
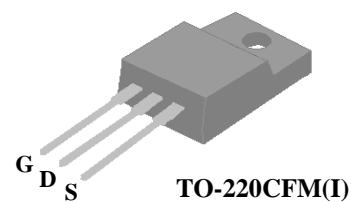




- ▼ 100% Avalanche Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



BV_{DSS}	500V
$R_{DS(ON)}$	1.4Ω
I_D^4	5.0A



Description

AP05N50 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-220CFM package is widely preferred for all commercial-industrial through hole applications. The mold compound provides a high isolation voltage capability and low thermal resistance between the tab and the external heat-sink.

Absolute Maximum Ratings@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}^4$	5.0	A
$I_D @ T_C = 100^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}^4$	2.8	A
I_{DM}	Pulsed Drain Current ¹	18	A
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation	31.3	W
$P_D @ T_A = 25^\circ\text{C}$	Total Power Dissipation	1.92	W
E_{AS}	Single Pulse Avalanche Energy ²	4.5	mJ
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-c}	Maximum Thermal Resistance, Junction-case	4.0	°C/W
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient	65	°C/W



Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	500	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ³	$V_{GS}=10V, I_D=2.7A$	-	-	1.4	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=2.7A$	-	2.4	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=500V, V_{GS}=0V$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Q_g	Total Gate Charge	$I_D=3.1A$	-	19	30	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=400V$	-	4.6	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	6.3	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=250V$	-	11	-	ns
t_r	Rise Time	$I_D=3.1A$	-	8	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=12\Omega$	-	32	-	ns
t_f	Fall Time	$V_{GS}=10V$	-	10	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	985	1580	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	85	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	3.3	-	pF
R_g	Gate Resistance	f=1.0MHz	-	2.5	-	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ³	$T_j=25^\circ C, I_S=4.5A, V_{GS}=0V$	-	-	1.5	V
t_{rr}	Reverse Recovery Time	$I_S=3.1A, V_{GS}=0V,$	-	300	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	2.6	-	μC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Starting $T_j=25^\circ C$, $V_{DD}=50V$, $L=1mH$, $R_G=25\Omega$, $I_{AS}=3A$.
- 3.Pulse test
- 4.Ensure that the junction temperature does not exceed $T_{Jmax.}$.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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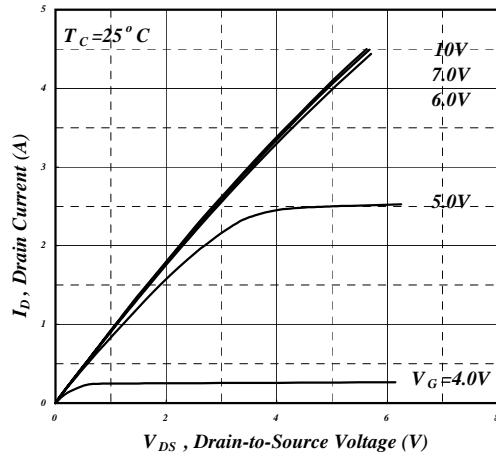


Fig 1. Typical Output Characteristics

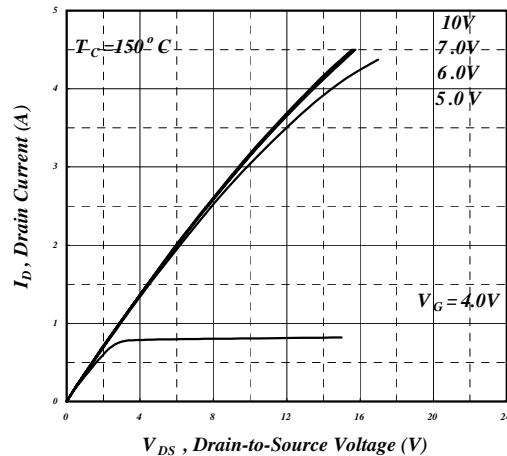


Fig 2. Typical Output Characteristics

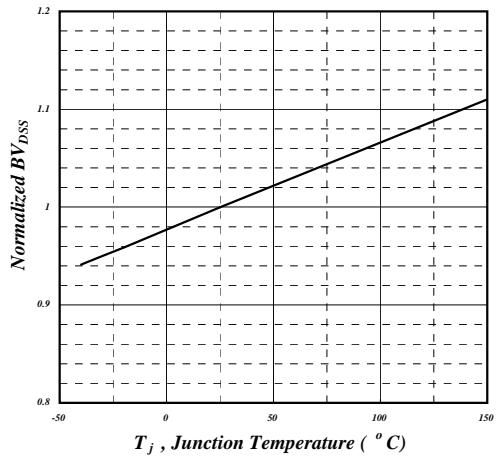
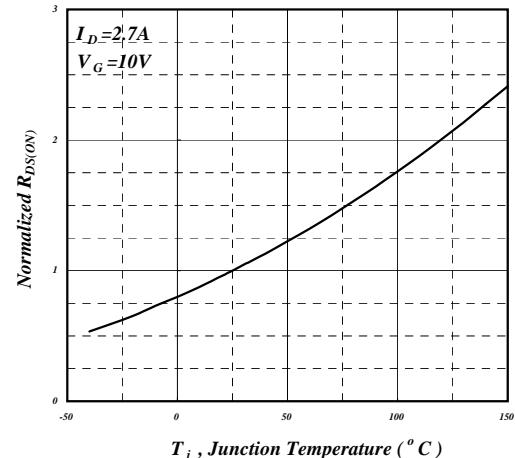
Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature

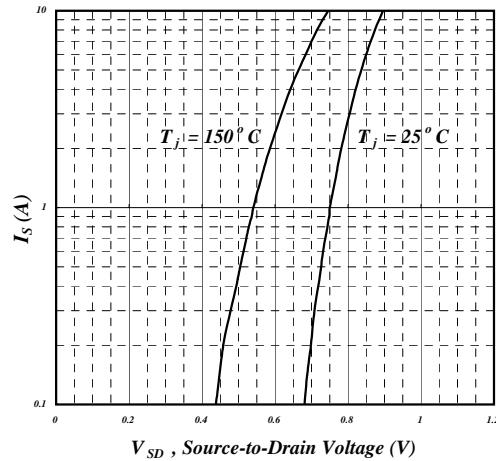


Fig 5. Forward Characteristic of Reverse Diode

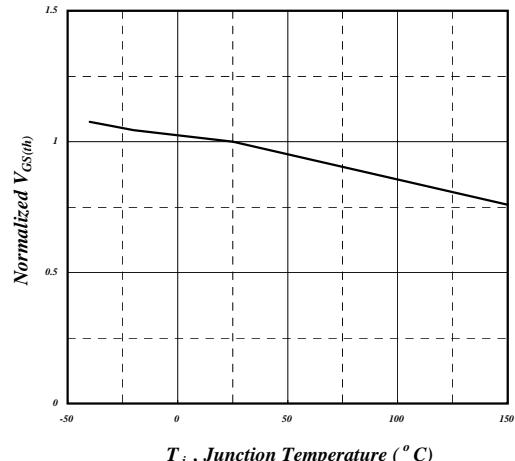
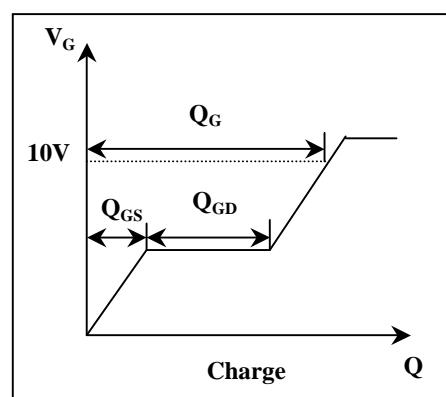
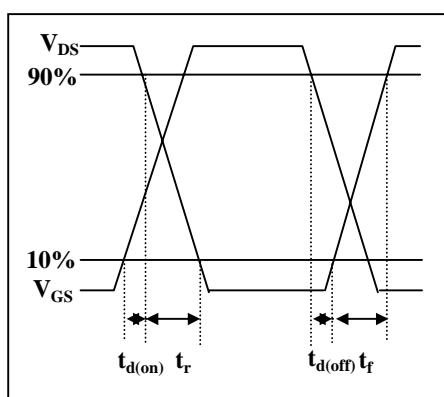
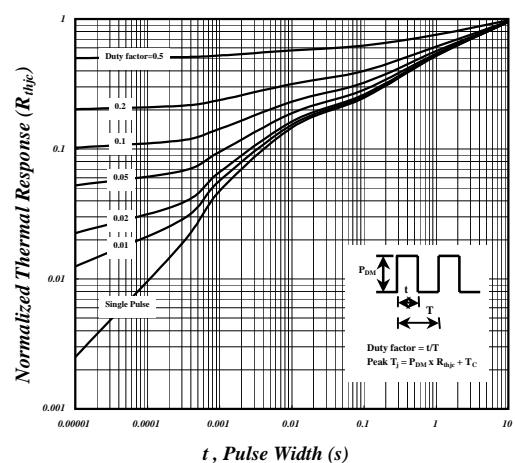
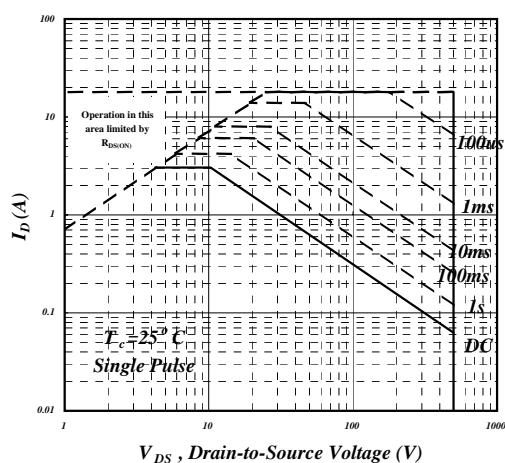
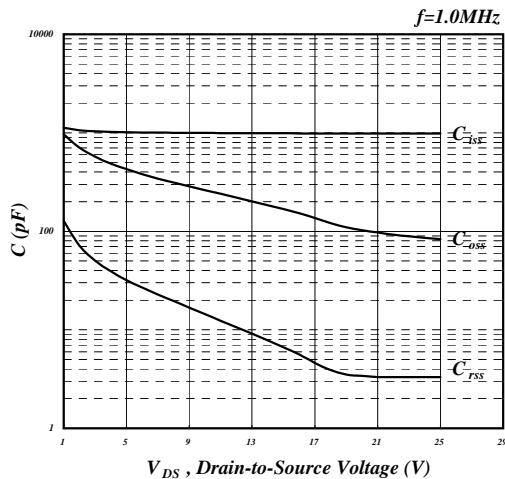
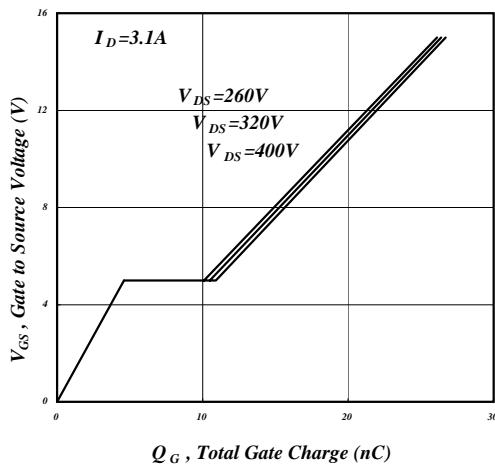


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

AP05N50I-HF





AP05N50I-HF

MARKING INFORMATION

